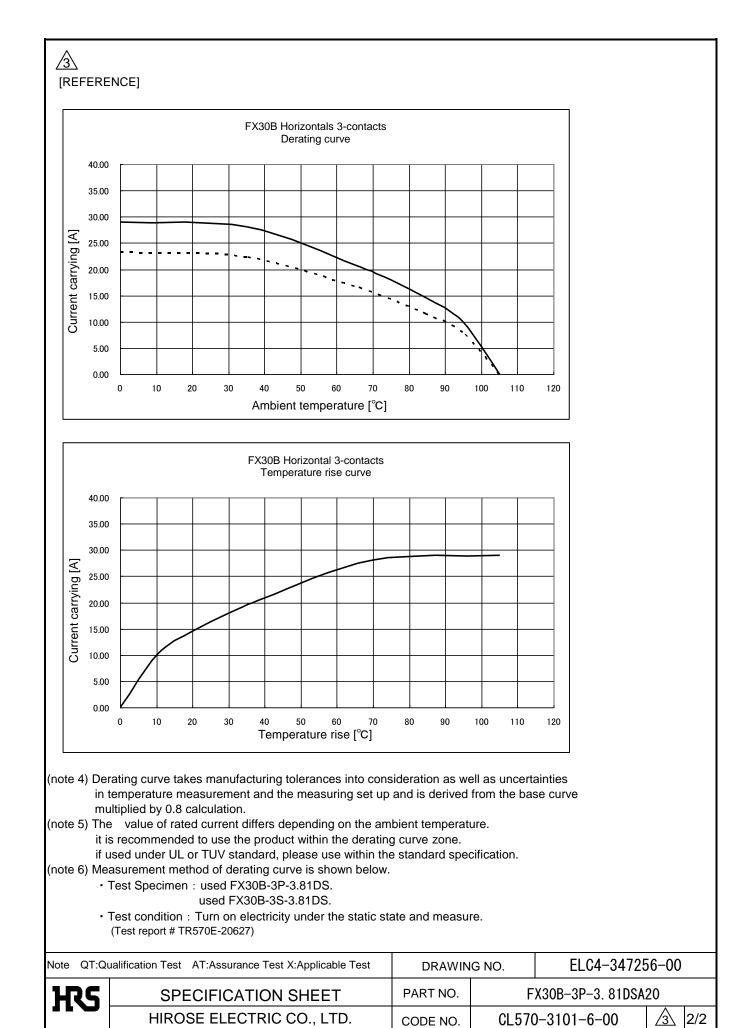
	Applic	able stand	ard 🔬	UL : UL1977, C-UL : CSA2	22.2 No.1	182.3-M1	987, -	TÜV : EI	N61984	4:2009 ⁽³⁾		
		Volta		250 V AC/DC(UL/C-UL)				perating emperature Range		-55 °C to 10	5 °C ⁽¹	1)
		Voltage 3		150V AC/DC(TÜV)		F	Dperatin Iumidity	g Relative Humidity				max
RA	TING	Current 3		22 A (AMBIENT TEPM 25℃) 15 A (UL/C-UL) 16 A (TÜV)			Storage empera	ture Ra	Range -10 °C to 60)
								Humidity Range 40 % to 70				
				SPEC		ATION	S				-	
	ITE			TEST METHOD			REQUIREMENTS				QT	AT
	VSTRU						1				×	
General Examination Marking			Visually and by measuring instrument. Confirmed visually.				According to drawing.					×
	<u> </u>			-							×	×
		CHARAC									<u> </u>	1
Contact Resistance			10 mA(DC or 1000Hz)				2 m Ω MAX. 1000 M Ω MIN.				×	-
Insulation Resistance Voltage Proof			1000 V DC.						, brook	douro	×	-
	-		1800 V AC for 1 min. No flashover or breakdown. ACTERISTICS								×	_
		AL CHAR									<u> </u>	-
	tion and drawal Fo	irces	Measured by applicable connector.				Insertion Force: 15 N MAX. Withdrawal Force: 0.6 N MIN.				×	_
			100 times insertions and extractions.				 (1) Contact Resistance: 5 m Ω MAX. 				×	_
Mechanical Operation							 Contact Resistance. 5 ms MAX. No damage, crack and looseness of parts. 					
Vibration			Frequency 10 to 55 to 10Hz, approx 5min				(1) No electrical discontinuity of 1 μ s. × –					
			Single amplitude : 0.75 mm, 10 cycles for 3 axial directions.				 No damage, crack and looseness of parts. 					
Shoc	k		490 m/s ² , duration of pulse 11 ms, 3 times to both directions in 3 axial directions.								×	-
ΕNV	/IRONN	IENTAL C	HARACT	ERISTICS							I	
	p Heat			at 40±2 °C, 90 ~ 95 %,	96 ±4	h.	① Cor	ntact Re	sistanc	ce:5mΩ MAX.	×	_
(Steady State)							<u> </u>			nce: 1000 MΩ MIN.		
Rapid Change of Temperature			Temperature -55 → +105 °C Time 30 → 30 min.				③ No damage, crack and looseness of parts.				×	-
			under 5 cycles. (Relocation time to chamber: within 2~3 MIN)									
Dry heat			Exposed at +105 \pm 2°C for 96 \pm 4h.								×	—
Cold			Exposed at -55±2°C for 96±4h.								×	-
Sulfur Dioxide			Exposed at 25±2°C, 75±5%RH, 25 PPM for 96h±4h.				 Contact Resistance: 5m Ω MAX. No defect such as corrosion which impairs 					-
							the function of connector.					
Resistance to Soldering Heat			Solder bath : Solder temperature 260±5°C for immersion, duration 10±1sec. Soldering irons : 380°C MAX. for 10 sec.				No deformation of case of excessive looseness					—
							of the terminal.					
			Soldered at solder temperature 240±3°C				A new uniform coating of solder shall cover a x -					
			for immersion, duration 3 sec.				minimum of 95 % of the surface being immersed.					
	COUNT	- D	I ESCRIPTIO	ON OF REVISIONS		DESIG	INED			CHECKED	DATE	
∕₿∖	3		DIS-	F-00001906	1	TS. 0	ONO			HT. YAMAGUCHI	16. 12. 16	
REMARKS ⁽¹⁾ Include temperature rise caused by current-carrying.								APPRO	OVED	HS. OKAWA		03.07
	(2	•	•	a long-term storage state roduct before assembly to PCB. 2 type of terminals :dip solder contacts.				CHEC	KED	KI. HIROKAWA	(AWA 13.03.	
	(3		•					DESIG		DK. AIMOTO		
			<i>.</i>								13.03.07	
Unle				to JIS-C-5402,IEC60512			DRAWN		WN	DK. AIMOTO		
Note	QT:Qu	alification Tes	st AT:Ass	urance Test X:Applicable Te	DI	RAWIN	NG NO. ELC4-347256		-00			
Н	RS	SPECIFICATION SHEET				PART	PART NO.		FX30B-3P-3. 81DSA20			1
		HIROSE ELECTRIC CO., LTD.				CODE	NO.	CL570-3101-6-00 3 1/2				

FORM HD0011-2-1



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